## Highly oriented VO $_2$ thin Ims prepared by sol-gel deposition method

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## Abstract

Highly oriented VO<sub>2</sub> thin In s were grown on sapphire substrates by the sol-gel m ethod that includes a low pressure annealing in an oxygen atmosphere. This reduction process electively promotes the formation of the VO<sub>2</sub> phase over a relatively wide range of pressures below 100 m Torr and temperatures above 400 C.X-ray dil raction analysis showed that as deposited In s crystallize directly to the VO<sub>2</sub> phase without passing through intermediate phases. VO<sub>2</sub> In shave been found to be with [100]- and [010]-preferred orientations on A  $\frac{1}{2}$ O<sub>3</sub> (1012) and A  $\frac{1}{2}$ O<sub>3</sub> (1010) substrates, respectively. Both In s undergo a m etal-insulator transition with an abrupt change in resistance, with dil erent transition behaviors observed for the dil erently oriented In s. For the [010]-oriented VO<sub>2</sub> In s a larger change in resistance of 1.2 10<sup>4</sup> and a low er transition temperature are found compared to the values obtained for the [100]-oriented In s.

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Vanadium dioxide (VO<sub>2</sub>) has been known to undergo the metal-insulator transition (M IT) near 68 C accompanied by abrupt changes in electrical resistivity and infrared transmission.<sup>14</sup> These transition properties make VO<sub>2</sub> Im s suitable for technological applications such as electrical switches and electro-optical modulators.<sup>375</sup> VO<sub>2</sub> Im s have shown reproducible switching characteristics without sample degradation, while bulk materials did not endure repeated transitions due to stress. A lthough Im swith transition characteristics comparable to single crystal have been grown, there have not yet been any representative devices realized using this system. One of the reasons may be the stabilization of VO<sub>2</sub> phase. The form ation of VO<sub>2</sub> phase is complicated due to the fact that there are several phases in vanadium oxide system with oxygen stoichiom etry. Establishing a process for the fabrication of VO<sub>2</sub> Im that possesses stable transition characteristics is crucial for the realization of devices.

Up to now,  $VO_2$  Im s have been fabricated by various methods such as pulsed laser deposition,  $6^{9}$  sputtering,  $10^{12}$  and chem ical vapor deposition  $13^{13}$ . Among these methods, researchers have focused on the solgelm ethod for depositing VO<sub>2</sub> Im s because it has many advantages such as low cost, large area deposition, and the feasibility of metal-doping.<sup>15 {17</sup> Fabrication of lms with a variety of transition properties is needed in order to satisfy particular device speci cations. The switching behavior of the MIT strongly depends on the crystallinity and the stoichiom etry of the lm s. The sol-gelm ethod can easily make lm s with various stoichiom etries and metal dopants, thus permitting the growth of num erous In swith a speci c transition behavior. Therefore, this method is suitable for fabricating In s for switching devices. However, the form ation of the pure phase is not easy even when employing the sol-gel technique due to the di culty in controlling the annealing condition. The annealing regime of the lm shasbeen known to be crucial for form ing the VO  $_2$  phase. It has been reported that a reducing gas atm osphere at a low pressure is required for successful phase formation. Moreover, vanadium oxide system undergoes successive reduction with increasing annealing temperature.<sup>15;17</sup> This means that the lm s pass through num erous intermediate phases during the annealing process, thus resulting in a narrower fabrication

window.

In this research, we have successfully fabricated  $VO_2$  Im s by the sol-gelm ethod with a more simplied annealing process. The form ation of the  $VO_2$  phase was a ected by annealing in oxygen only without a reducing gas. The Im s have highly preferred orientations related to the sapphire substrates. We investigate the dimensional characteristics of the transition behavior with respect to the Im orientation.

 $VO_2$  In swere grown on sapphire substrates by a sol-gelm ethod. Thism ethod consists of spin-coating and a subsequent annealing process under low pressure. The coating solutions were prepared by synthesizing the vanadium tri-isopropoxide,  $VO(OC_3H_7)_3$  (Stream Ltd. USA), in isopropanolusing a catalyst of acetic acid. The nalloll2 M solution concentration was thus prepared. The solution was spin-coated onto sapphire substrates with a spin rate of 2000 rpm for 20 s. The coated lm s were dried at 250 C for 3 m in on a hot plate to rem ove the excess alcohol. The procedure was performed in air to partially hydrolyze the alkoxide lm with ambient moisture and repeated three times in the same manner. The thickness per cycle was approximately 32 nm. The nallheat treatment was carried out at 410 C for 30 m in in air, which made the lm s turn orange-yellow in color. In order to form the  $VO_2$  phase through a reduction process, subsequent annealing of the lm s was done in a low pressure of oxygen.

An X-ray di ractom eter (XRD) using CuK was used to determ ine the lm orientation. The surface m orphology and the grain structure of the lm swere investigated by scanning electron m icroscopy (SEM). The electrical resistance of the lm swasm easured by using the four-probe m ethod.

Figure 1 shows X-ray di raction patterns of the lm s annealed at various tem peratures. The lm s were annealed at each tem perature for 10 m in at a pressure of 32 m Torr. The XRD -2 scans indicate that both lm s have a strong orientation relation to the sapphire substrate. The lm s on A  $l_2O_3$  (1012) are grown with a [100]-preferred direction, as shown in Fig. 1 (a). A s-deposited lm without an annealing has V  $_2O_5$  (001) peak, but its intensity is very weak compared to the completely crystallized lm s on sapphire.<sup>6</sup> This indicates that the

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degree of the lm crystallization to the V<sub>2</sub>O<sub>5</sub> phase is bw. For the lm s annealed over and at 400 C, the strong XRD peak related to the crystallization appears at a 2 value of 37, which corresponds to the VO<sub>2</sub> (200) rejection of the monoclinic phase. Although the small peak with other direction exists, we can con rm that the lm s have a strong orientation from the comparative analysis of the peaks. The crystallization behavior of the lm s grow n on A  $l_2O_3$  (1010) is also similar to that on (1012) except that the [010]-preferred orientation is obtained, as shown in Fig. 1 (b). The lm s have a strong (040) peak of the monoclinic VO<sub>2</sub> phase. We also found that the phase form ation of the lm s during the annealing process depends largely on the annealing temperature rather than the pressure. A stable VO<sub>2</sub> phase is form ed in the range from a few m Torr to near 100 m Torr.

The fact that no other peak expected for VO<sub>2</sub> phase is observed in all In s annealed at various temperatures is of particular interest. A s-deposited In s have been known to undergo a reduction process to the nalVO<sub>2</sub> phase passing through interm ediate phases such as V<sub>3</sub>O<sub>7</sub> and V<sub>6</sub>O<sub>13</sub> during the annealing process.<sup>15;17</sup> That is, the reduction of vanadium oxide successively occurs as the annealing temperature increases. However, our results show that the annealing process does not follow the successive reduction of the vanadium oxide and thus no interm ediate phases appear at the various annealing temperatures. G enerally, the annealing process was carried out under reducing gasm ixture as like H<sub>2</sub> and CO, whereas our process was performed in oxygen only without reducing gases. A lthough the further study is required to understand completely the phase form ation, our simplied reducing process can be the origin of this phenom enon. Our fabrication process of VO<sub>2</sub> In s has considerable advantages over those in previous reports.<sup>15;17</sup> Since various interm ediate phases are not generated during the fabrication process, there is a large process window for the production of high quality In .

Figure 2 shows SEM in ages of the  $\ln s$ . Optically, the color of the VO<sub>2</sub>  $\ln s$  is goldenbrown. The change of surface morphology of both  $\ln s$  grown on (1012) and (1010) with annealing temperature is similar. As shown in Fig. 2, as deposited  $\ln s$  without a subsequent annealing process show well-form ed grains although the crystallinity is very weak in

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the X-ray patterns of Fig. 1. Sm all grains are generated in the interior of initial grains, as illustrated in  $\[mbox{ In s annealed at 400 C. This im age may be related to the form ation of the VO<sub>2</sub> phase. Well crystallized <math>\[mbox{ In s of the VO<sub>2</sub> phase at 470 C have grains which are roundish in shape and the average grain size is estimated to be about 100 nm.$ 

Figure 3 shows the temperature dependence of the electrical resistance for both Ims. The characteristics of the resistance of the Ims can be another indicator of the Im quality. Them easurem entwasperform ed through sweep-up and -down processes. Both Ims undergo a metal-insulator transition with temperature. The Imresistance decreases exponentially with increasing temperature and then an abrupt drop occurs at the critical temperature. It has been reported that the increasing hole density leads to the breakdown of the sub-gap and thus the transition into the metallic state.<sup>3;18</sup> As shown in Fig. 3, the change in resistance gets to as large as 8.7 10<sup>3</sup> and 1.2 10<sup>4</sup> for the VO<sub>2</sub>/A  $\frac{1}{2}$ O<sub>3</sub> (1012) and the VO<sub>2</sub>/A  $\frac{1}{2}$ O<sub>3</sub> (1010) Ims, respectively. These values are comparable to those of the single crystal, which means that the Ims are highly oriented and possesses good stoichiom etry.<sup>10</sup> Hysteresis in the resistance also occurs during the sweep-up and -down processes of temperature.

The inset of Fig. 3 displays the change in resistance curves for the di erent annealing temperatures. The lms reveal di erent M II behaviors with respect to the crystallinity. The onset and sharpness of the transition are characterized by the plot of dR /dT for [100]-oriented lms as shown in Fig. 4(a). The transition width de ned as the full width at half maximum of this peak is as low as 0.6 C. The sharpness of the transition has been known to be related to the degree of m isorientation between adjacent grains.<sup>10</sup> W ell-m atched grains perm it an elective propagation of the metallic regions in the lms without additional energy loss. The VO<sub>2</sub> lms grown on (1012) have a lower transition width than 3.1 C for the lms on (1010), which indicates that the form er lms have higher in-plane alignment of grains.

Figure 4 (b) shows the change in the transition temperature  $(T_c)$  and the magnitude of the resistance change (R) for both of the lms annealed at various temperatures. T<sub>c</sub> is dened as the peak value of the dR/dT curve. The resistance of the lms annealed at 400 C decreases slow by with little change at a critical temperature. This indicates that the lms

are not totally crystallized although the crystallinity of VO<sub>2</sub> phase is con rm ed from the XRD patterns. Both of the lm s annealed above 430 C display good transition behaviors as evidenced by change in resistance but exhibit di erent transition characteristics. As shown in Fig. 4(b), for the VO<sub>2</sub>/A  $l_2O_3$  (1012) lm s, the transition temperature of 65 C alm ost doesn't change with annealing temperature above 430 C, while the resistance change slightly increases from 4.8 10<sup>3</sup> to 8.7 10<sup>3</sup>. For the VO<sub>2</sub>/A  $l_2O_3$  (1010) lm s, the transition temperature of the resistance change temperature slightly changes from 63 C to 60 C, while the magnitude of the resistance change change remains of order of 1.2 10<sup>4</sup> with increasing annealing temperature.

[010]-oriented VO<sub>2</sub> Im s show relatively higher R and lower T<sub>c</sub> than [100]-oriented Im s. This is consistent with previously reported results.<sup>9</sup> The direction in which the resistance was measured with respect to the Im orientation could in uence the transition characteristics. A further study is necessary to understand the di erent transition properties of both Im s in detail.

In conclusion,  $VO_2$  phase was well-form ed on sapphire substrates by using a sin pli ed annealing process. The  $VO_2$  In swere grown in a wide range of pressures from severalm Torr up to 100m Torr of oxygen atmosphere and at tem peratures above 400 C, without passing through any intermediate phases. The  $VO_2$  In s had a highly preferred orientation, and showed resistance changes as large as  $1.2 \, 10^4$  which is the comparable property of the single crystal.<sup>10</sup> D i erent transition properties were obtained depending on the Im orientation. O urm ethod with a simplied annealing process leads to the elective growth of high quality  $VO_2$  Im s.

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## REFERENCES

- <sup>1</sup>F.Morin, Phys. Rev. Lett., 3, 34 (1959).
- <sup>2</sup> S. Shin, S. Suga, M. Taniguchi, M. Fujisawa, H. Kanzaki, A. Fujimori, H. Daimon, Y. Ueda, K. Kosuge, and S. Kachi, Phys. Rev. B, 41, 4993 (1990).
- <sup>3</sup>H.T.Kim, B.G.Chae, D.H.Youn, S.L.Maeng, G.Kim, K.Y.Kang, and Y.S.Lim, New J.Phys., 6, 52 (2004).
- <sup>4</sup>H.T.Kim, B.G.Chae, D.H.Youn, G.Kim, K.Y.Kang, S.J.Lee, K.Kim, and Y.S. Lim, Appl. Phys. Lett., 86, 242101 (2005).
- <sup>5</sup> F.A. Chudnovskii, Sov. Phys. Tech. Phys., 20, 999 (1976).
- <sup>6</sup>B.G.Chae, D.H.Youn, H.T.Kim, S.L.Maeng, and K.Y.Kang, J.Kor.Phys.Soc., 44,884 (2004).
- <sup>7</sup>D.H.Youn, J.W. Lee, B.G. Chae, H.T.Kim, S.L.Maeng, and K.Y.Kang, J.Appl. Phys., 95, 1407 (2004).
- <sup>8</sup> Mark Borek, F.Qian, V.Nagabushnam, and R.K.Singh, Appl. Phys. Lett., 63, 3288 (1993).
- <sup>9</sup>D.H.Kim and H.S.Kwok, Appl. Phys. Lett., 65, 3188 (1994).
- <sup>10</sup> J.F. De Natale, P.J. Hood, and A.B. Harker, J. Appl. Phys., 66, 5844 (1989).
- <sup>11</sup>Y.Shigesato, M.Enomoto, and H.Odaka, Jpn.J.Appl. Phys., 39, 6016 (2000).
- <sup>12</sup> P. Jin, K. Yoshimura, and S. Tanemura, J. Vac. Sci. Technol. A, 15, 1113 (1997).
- <sup>13</sup> M.B. Sahana, G.N. Subbanna, and S.A. Shivashankar, J. Appl. Phys., 92, 6495 (2002).
- <sup>14</sup> H.L.M. Chang, H.You, J.Guo, and D.J.Lam, Appl. Surf. Sci., 48/49, 12(1991).
- <sup>15</sup>D.P.Partlow, S.R.Gurkovich, K.C.Radford, and L.J.Denes, J.Appl. Phys., 70, 443 (1991).

- <sup>16</sup>N.Ozer, Thin Solid Films, 305, 80 (1997).
- <sup>17</sup>Y.Ningyi, L. Jinhua, and L. Chenglu, Appl. Surf. Sci., 191, 176 (2002).
- <sup>18</sup>G.Stefanovich, A.Pergament, and D.Stefanovich, J.Phys.: Condens.Matter, 12, 8837 (2000).

## FIGURES

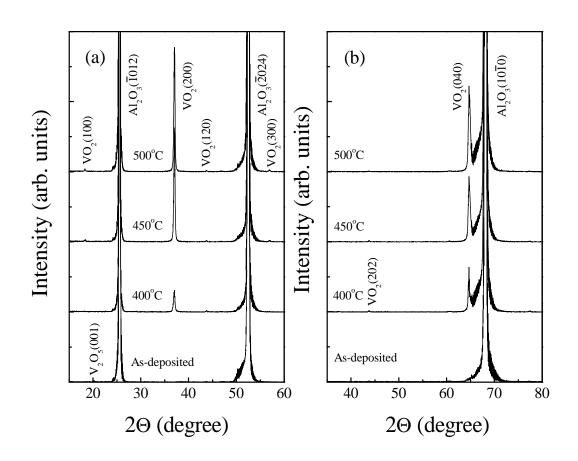


FIG.1. X-ray di raction patterns of vanadium oxide  $\ln s$  grown on (a) A l<sub>2</sub>O<sub>3</sub> (1012) and (b) A l<sub>2</sub>O<sub>3</sub> (1010) substrates. The  $\ln s$  were annealed at various temperatures in 32 m Torr of oxygen atm osphere.

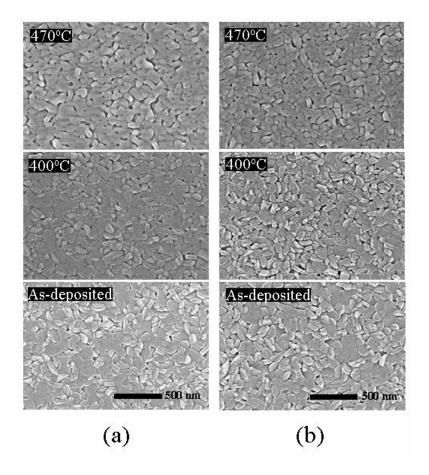


FIG.2. SEM in ages of vanadium oxide  $\,\rm lm\,s\,grow\,n$  on (a) A  $\rm l_2O_3$  (1012) and (b) A  $\rm l_2O_3$  (1010) substrates.

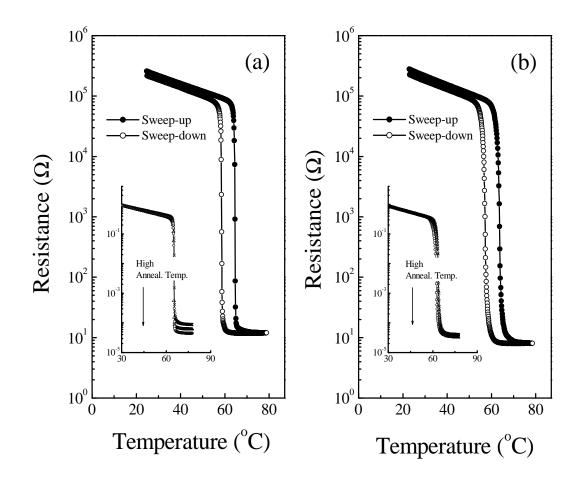
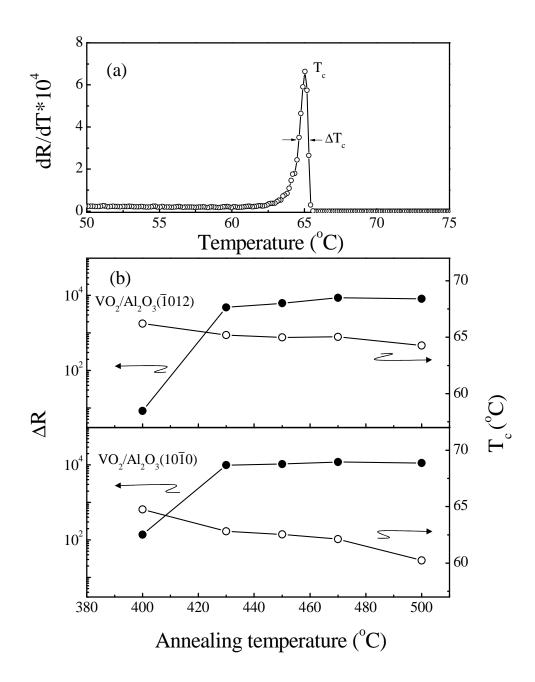


FIG. 3. Changes in resistance for (a) the  $VO_2/A \downarrow O_3$  (1012) and (b) the  $VO_2/A \downarrow O_3$  (1010) In s. The inset displays the changes in resistance with annealing temperature with the curves normalized for convenience.



F IG . 4. (a) Derivative of the change in the resistance with respect to temperature for the lm on A  $\frac{1}{2}$ O  $_3$  (1012). (b) C hanges in the magnitude of the resistance change and transition temperature as a function of annealing temperature for the lm s on A  $\frac{1}{2}$ O  $_3$  (1012) and A  $\frac{1}{2}$ O  $_3$  (1010).